9-215460-0 ACTIVE

Micro-MaTch | Micro-MaTch Industrial

TE Internal #: 9-215460-0

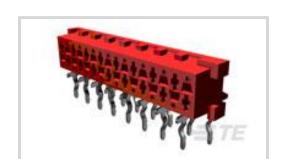
Ribbon Cable Connectors, Cable-to-Board, 20 Position, 2.54 mm [.1 in] Centerline, Right Angle, Through Hole - Solder, 2 Row, Micro-

MaTch Industrial

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Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors



Connector System: Cable-to-Board

Number of Positions: 20

Centerline (Pitch): 2.54 mm [.1 in]
PCB Mount Retention: With

PCB Mount Retention Type: Kinked Legs

Features

Product Type Features

Ribbon Cable Connector Type	Female-on-Board
Connector Product Type	Connector Assembly
Connector System	Cable-to-Board
Connector & Housing Type	Receptacle
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Number of Positions	20
PCB Mount Orientation	Right Angle
Number of Rows	2

Electrical Characteristics

Insulation Resistance	1000 ΜΩ
Operating Voltage	100 VAC

Body Features

Primary Product Color	Red
Connector Profile	Standard

Contact Features

PCB Contact Termination Area Plating Material Thickness	3 – 5 μm[118.11 – 196.85 μin]
Contact Layout	Staggered



Contact Mating Area Plating Meterial Thickness 3 - 5 µm(118.11 - 196.85 µin) Contact Mating Area Plating Material Contact Mating Area Plating Material Finish Mattle Contact Mating Area Plating Material Finish Contact During Area Plating Material Finish Mattle Contact Underprating Material PCB Contact Termination Area Plating Material Contact Base Material Contact Base Material Contact Base Material Contact Base Material Contact Current Rating (Max) 1.5 A Termination Features Termination Nethod to Printed Circuit Board Mechanical Attachment With Mating Alignment Without PCB Mount Alignment PCB Mount Alignment PCB Mount Retention Type Mating Alignment Type Mating Alignment Type Mount Retention Connector Mounting Type Board Mount Connector Mounting Type Housing Retention Side Housing Material Glass Filled PBT Contectine (Pich) Dimensions Row-to-Row Spacing 1.5 mm(.059 in) Usage Conditions Operating Imperoratire Range 40 - 105 °C 40 - 221 °F Operation/Application Ginait Application		
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Connector Mounting Type Housing Features Mating Entry Location Housing Material Centerline (Pitch) Dimensions Row-to-Row Spacing 1.5 mm[.059 in] Usage Conditions Operating Temperature Range -40 – 105 °C[-40 – 221 °F] Operation/Application Circuit Application Signal Industry Standards UL Rating Recognized	Mating Alignment Type	Polarization
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Row-to-Row Spacing 1.5 mm[.059 in] Usage Conditions Operating Temperature Range -40 - 105 °C[-40 - 221 °F] Operation/Application Circuit Application Signal Industry Standards UL Rating Recognized	Centerline (Pitch)	2.54 mm[.1 in]
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Industry Standards UL Rating Recognized	Operation/Application	
UL Rating Recognized	Circuit Application	Signal
	Industry Standards	
Agency/Standard UL	UL Rating	Recognized
	Agency/Standard	UL



Approved Standards	UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	250
Packaging Method	Box

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





TE Part # CAT-M5833-M2934 Male-on-Board Connector, Micro-MaTch



Male-on-Wire Connector, Micro-MaTch



Also in the Series | Micro-MaTch Industrial



Board-In Connectors(20)



Insertion & Extraction Tools(1)



PCB Headers & Receptacles(1)



Pluggable I/O Cable Assemblies(52)



Ribbon Cable Connectors(185)

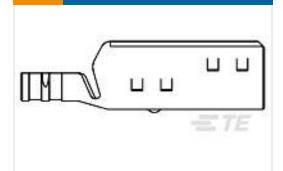


Wire-to-Board Connector Contacts(4)

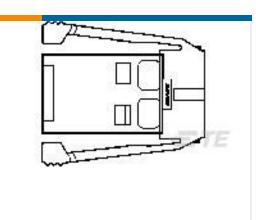
Customers Also Bought



TE Part #8-215570-4 MICRO-MATCH PBC.14P



TE Part #520461-1 4 SDL RND SHIELD, BTTM, BULK PKG



TE Part #5-520424-1 4 SDL RND PLUG ASSY 50 SERIES



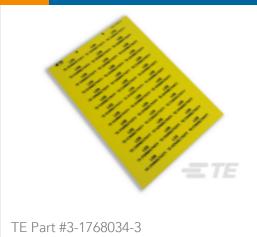
MICR-MATCH FSID P



TE Part #2-1879215-3 CPF 0402 6K81 0.1% 25PPM 1K RL



TE Part #4-1415899-5 RZ01-1C3-D024



LEB-3460P-9

TE Part #GV-6 GASKETS FOR SIZE 6 M ICROLITE /ASDD 9 WAY



Documents

Product Drawings

MICRO-MATCH FSID P

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_9-215460-0_J.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_9-215460-0_J.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_9-215460-0_J.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

Micro-MaTch Catalog

English

Ribbon Cable Interconnect Solutions

English

Centerline Micro-Match Connector Series

English

Product Specifications

Product Specification

English

Product Environmental Compliance

MD_9-215460-0_03142018936_dmtec

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MD_9-215460-0_03142018936_dmtec

English

Agency Approvals

UL Report

English